

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

David R. Hembree

Serial No.: 10/624,332

Filed: July 22, 2003

For: CHIP ON BOARD AND HEAT SINK
ATTACHMENT METHODS

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VIA ELECTRONIC FILING
June 26, 2007

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES
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Sir:


1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.
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8000 South Federal Way
Boise, Idaho 83707-0006
2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.

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4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,

A handwritten signature in cursive script, appearing to read "James R. Duzan".

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